

Electronic Patent Application Fee Transmittal				
Application Number:	10082010			
Filing Date:	22-Feb-2002			
Title of Invention:	Slurry and method for chemical mechanical polishing of metal structures including refractory metal based barrier layers			
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Filer:	Gregory Marc Lefkowitz/GAIL OCHOCKI			
Attorney Docket Number:	5853-224			
Filed as Small Entity				
Utility under 35 USC 111(a) Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	2801	1	405	405
Total in USD (\$)				405